## 3. 3 Plasma sheath

Why plasma sheath? Consider thermal velocity (eT/m)^1/2 It is at least 100x higher for electrons than for ions



FIGURE 1.10. The formation of plasma sheaths: (a) initial ion and electron densities and potential; (b) densities, electric field, and potential after formation of the sheath.



electron and ion flux has to equal at floating wall

$$\Gamma_{\rm i} = n_{\rm s} u_{\rm B} \qquad \Gamma_{\rm e} = \frac{1}{4} n_{\rm s} \sqrt{\frac{8k_{\rm b}T_e}{\pi m}} e^{\frac{eV}{k_{\rm b}T_e}}$$

$$V_{w} = \frac{k_{\rm b}T_{\rm e}}{2e}\ln\left(\frac{2\pi m}{M}\right)$$

calculation for Ar discharge with  $T_e = 2 \text{ eV}$ ,  $n=10^8 \text{ cm}^{-3}$ : floating potential approx.  $5T_e = 10 \text{ V}$ , sheath thickness approx.  $5\lambda_D = 0.37 \text{ mm}$ 

## Plasma sheath – Child-Langmuir sheath

high-voltage sheath (when a voltage is applied)

Sheath can be artificially divided into Debye sheath which contains electrons and high-voltage Child-Langmuir sheath which has ions only.

Then, current density j, voltage drop  $V_0$  and sheath thickness d are related by the Child-Langmuir Law of Space-Charge-Limited Diodes

$$j = \frac{4}{9} \left(\frac{2e}{M}\right)^{1/2} \frac{\varepsilon_0 V_0^{3/2}}{d^2} \qquad d = \frac{2}{3} \left(\frac{2V_0}{T_{eV}}\right)^{3/4} \lambda_D$$

following previous example with assumption  $V_0 = 400$  V: d =  $30\lambda_D$ , total sheath thickness  $35\lambda_D$ , i.e. about 1 cm





Fig. 3. An exact calculation for a plane sheath shows that C-L scaling is not followed unless the sheath is very thick (log-log scale).